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EXAMINER			Ĭ				FILING (DATE IF
INITIAL	DOCUMENT NUMBER	DATE	NAME		CLASS	SUBCLASS	APPROPRIATE	
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	DOCUMENT NUMBER	DATE		COUNTRY		SUBCLASS	YES	NO
HEA	DE10222609.1A1	5/23/02	Germany					х
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Mul allant? 10/13/65								
EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP §609; Draw line through								